



# Ultra Low Profile 0603 **3dB Hybrid Coupler**



## **Description:**

The X4C40L1-03G is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for 5G applications. The X4C40L1-03G is available on tape and reel for pick and place high volume manufacturing.

All of the Xinger components are constructed from ceramic filled PTFE composites, which possess excellent electrical and mechanical stability. All parts have been subjected to rigorous qualification testing and units are 100% RF tested. Produced in an ENIG final finish.

## **Electrical Specifications\*\***

eatures:	Frequency	Isolation	Return Loss	Amplitude Balance
3100-5100 MHz				
5G Applications	MHz	dB Min	dB Min	dB Max
Very Low Loss				
Tight Amplitude Balance	3100-3700	20	18	±0.5
High Isolation	3700-5100	20	18	±0.5
Production Friendly	Insertion	Phase	Power	Operating Temp.
Tape and Reel	Loss			- p
	dB Max	Degrees	Avg. CW Watts @105°C	°C
	0.3	90 ±4	3*	-55-+140
	0.4	90 ±4	3*	-55-+140

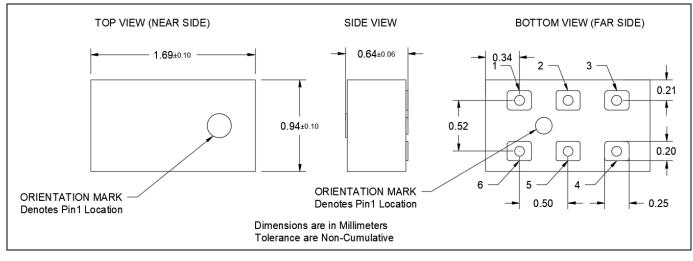
\*\*Specification based on performance of unit properly installed on TTM Test Board with small signal applied. \*Specifications subject to change without notice. Refer to parameter definitions for details.

## **Mechanical Outline:**

Features:

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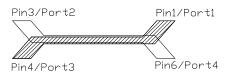
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## Hybrid Coupler Pin Configuration

The X4C40L1-03G has an orientation marker to denote Pin 1. Once port one has been identified the other ports are known automatically. Please see the chart below for clarification:

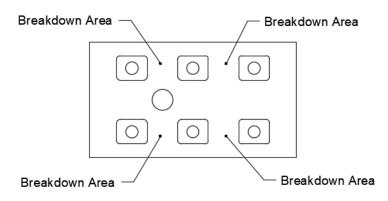


Configuration	Pin1/Port 1	Pin 2	Pin 3/Port2	Pin 4/Port3	Pin 5	Pin 6/Port4
Splitter	Input	GND	Isolated	−3dB∠ <i>θ</i> − 90	GND	−3dB∠θ
Splitter	Isolated	GND	Input	−3dB∠θ	GND	−3dB∠ <i>θ</i> − 90
Splitter	−3dB∠ <i>θ</i> − 90	GND	-3dB∠θ	Input	GND	Isolated
Splitter	−3dB∠θ	GND	−3dB∠ <i>θ</i> − 90	Isolated	GND	Input
*Combiner	A∠ <i>θ</i> − 90	GND	A∠θ	Isolated	GND	Output
*Combiner	A∠θ	GND	A∠ <i>θ</i> − 90	Output	GND	Isolated
*Combiner	Isolated	GND	Output	A∠ <i>θ</i> − 90	GND	A∠θ
*Combiner	Output	GND	Isolated	A∠θ	GND	$A \angle \theta - 90$

\*Notes: "A" is the amplitude of the applied signals. When two quadrature signals with equal amplitudes are applied to the coupler as described in the table, they will combine at the output port. If the amplitudes are not equal, some of the applied energy will be directed to the isolated port. The actual phase,  $\angle \theta$  or amplitude at a given frequency for all ports, can be seen in our deembedded s-parameters that can be downloaded at <u>www.ttm.com.</u>

## **Peak Power Handling**

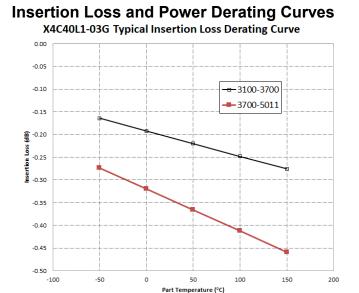
High-Pot testing of these components during the qualification procedure resulted in a minimum breakdown voltage of 1Kv (minimum recorded value). This voltage level corresponds to a breakdown resistance capable of handling at least 12dB peaks over average power levels, for very short durations. The breakdown location consistently occurred across the pads and the ground bar (see illustration below). The breakdown levels at these points will be affected by any contamination in the gap area around these pads. These areas must be kept clean for optimum performance. It is recommended that the user test for voltage breakdown under the maximum operating conditions and over worst case modulation induced power peaking. This evaluation should also include extreme environmental conditions (such as high humidity).



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# X4C40L1-03G Power Derating Curve

X4C40L1-03G

Rev D

## Insertion Loss Derating

The insertion loss, at a given frequency, of a group of couplers is measured at  $25^{\circ}$ C and then averaged. The measurements are performed under small signal conditions (i.e. using a Vector Network Analyzer). The process is repeated at -55°C, 105°C and 140°C. A best-fit line for the measured data is computed and then plotted from -55°C to 140°C.

## **Power Derating**

The power handling and corresponding power derating plots are a function of the thermal resistance, mounting surface temperature (base plate temperature), maximum continuous operating temperature of the coupler, and the thermal insertion loss. The thermal insertion loss is defined in the Power Handling section of the data sheet.

As the mounting interface temperature approaches the maximum continuous operating temperature, the power handling decreases to zero.

If mounting temperature is greater than 105°C, Xinger coupler will perform reliably as long as the input power is derated to the curve above.

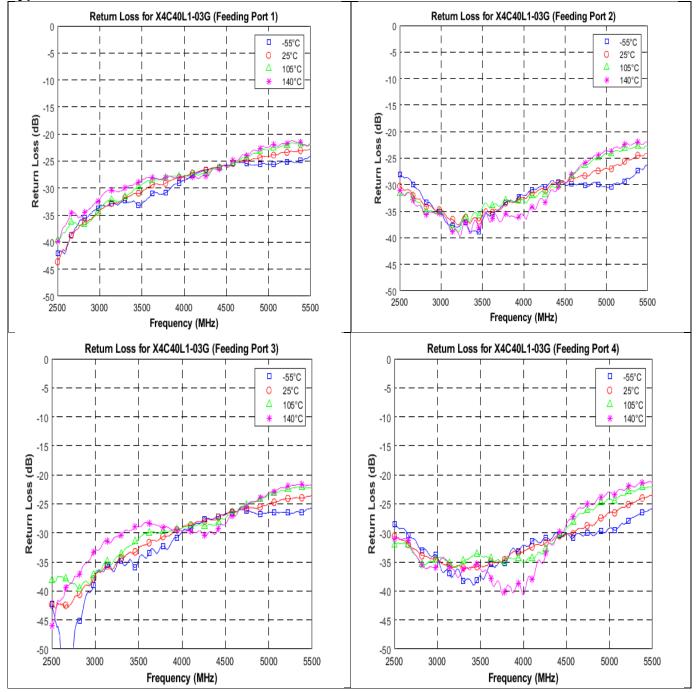
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X4C40L1-03G Rev D

# Typical Performance: 2500 MHz to 5500 MHz

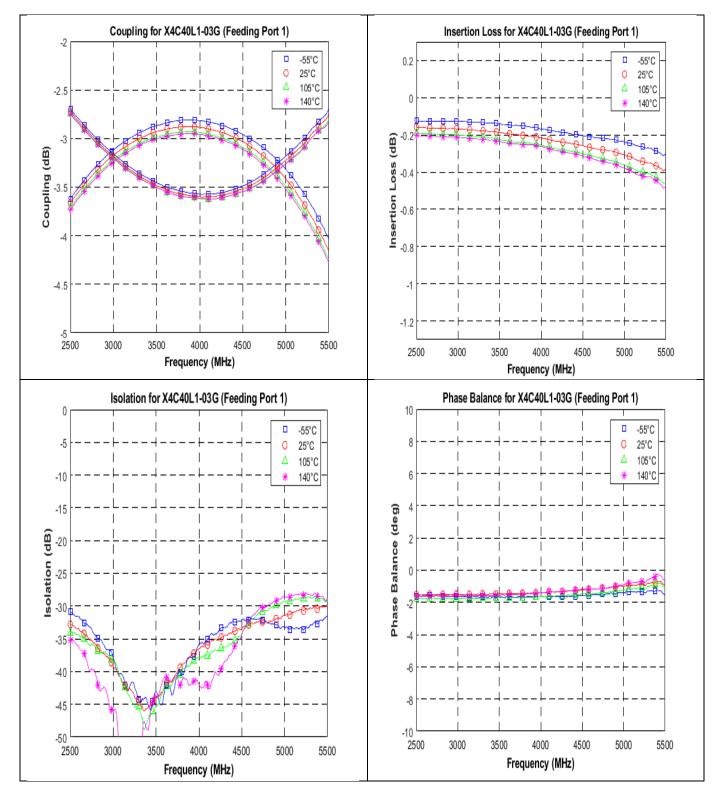


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## **Definition of Measured Specification**

Parameter	Definition	Mathematical Representation	
VSWR (Voltage Standing Wave Ratio)	The impedance match of the coupler to a 50Ω system. A VSWR of 1:1 is optimal.	$VSWR = \frac{V_{max}}{V_{min}}$ Vmax = voltage maxima of a standing wave Vmin = voltage minima of a standing wave	
Return Loss	The impedance match of the coupler to a 50Ω system. Return Loss is an alternate means to express VSWR.	Return Loss(dB) = $20\log \frac{VSWR + 1}{VSWR - 1}$	
Insertion Loss	The input power divided by the sum of the power at the two output ports.	Insertion Loss(dB) = 10log $\frac{P_{in}}{P_{cpl} + P_{direct}}$	
Isolation	The input power divided by the power at the isolated port.	Isolation(dB) = $10\log \frac{P_{in}}{P_{iso}}$	
Amplitude Balance	The power at each output divided by the average power of the two outputs.	$\frac{10\log \frac{P_{cpl}}{(P_{cpl}+P_{direct})/2}}{P_{direct}}$ and $\frac{10\log \frac{P_{direct}}{(P_{cpl}+P_{direct})/2}}$	
Phase Balance	The difference in phase angle between the two output ports.	Phase at coupled port – Phase at direct port	
Group Delay (GD-C)	Group delay is average of group delay's from input port to the coupled port	Average (GD-C)	
Group Delay (GD-DC)	Group delay is average of group delay's from input port to the direct port	Average (GD-DC)	

\*100% RF test is performed per spec definition for every pin configuration.

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## **Packaging and Ordering Information:**

Parts are available in reel and are packaged per EIA 481-D. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel.

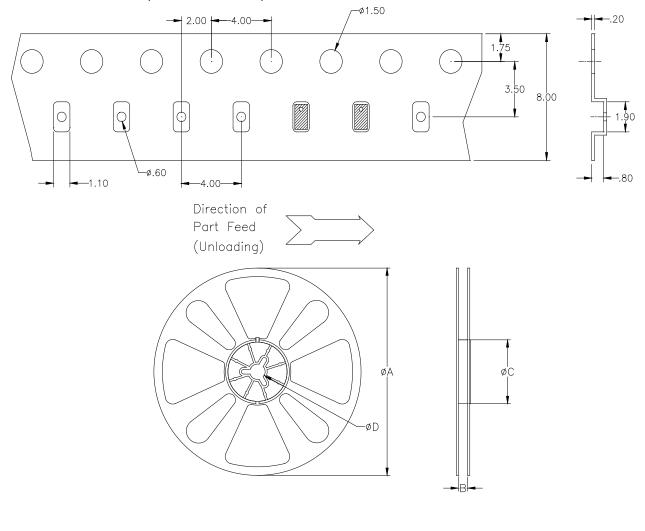


TABLE 1						
QUANTITY/REEL	REEL DIMENSIONS mm					
	ØA	177.80				
4000	В	8.00				
	øС	50.80				
	øD	13.00				

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